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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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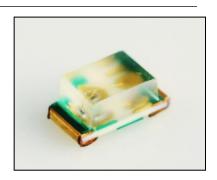






# **Standard Product Specifications**

# VCDB1111C-5AY3B-TR



### **Features**

Package	1608 Flat lens type, Milky white resin, Blue color emitting LED Outer dimension 1.6 x 0.8 x 0.7mm ( L x W x H )
Product features	<ul> <li>Equivalent to JEDEC level 3 (IPC/JEDEC J-STD-020D)</li> <li>Lead-free soldering compatible</li> <li>RoHS compliant</li> </ul>

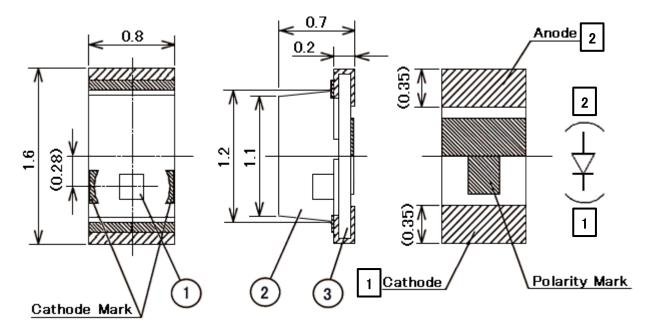
# **Recommended Applications**

•Indicators for Automotive, Consumer equipment etc.

# **Outline Dimensions**

# VCDB1111C-5AY3B-TR

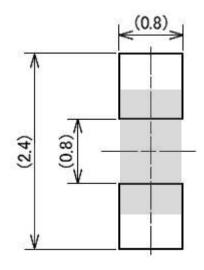
Unit : mm
Weight : 1.4mg
Tolerance :  $\pm 0.1$ 



NO.	PART NAME	MATERIAL	QTY.
1	LED Die	InGaN	1
2	Mold resin	Epoxy Resin	1
3	Substrate	Glass Fabrics	1

# **Recommended Pad**

Unit:mm



# **Specifications**

#### [ Product Overview ]

DIE MATERIAL	InGaN
EMITTING COLOR	Blue
resin color	Milky White

#### **[** Absolute Maximum Ratings

(Ta=25°C)

ІТЕМ	SYMBOL	maximum ratings	UNITS	
Power Dissipation	$P_{d}$	27	mW	
Forward Current	I <sub>F</sub>	8	mA	
Repetitive Peak Forward Current "1ms, 1/20 duty"	I <sub>FRM</sub>	24	mA	
I <sub>F</sub> Derate Linearly from "85°C"	ΔIF	0.50	mA/°C	
I <sub>FRM</sub> Derate Linearly from "85°C"	Δ I <sub>FRM</sub>	1.2	mA/°C	
Reverse Voltage	V <sub>R</sub>	5	V	
Operating Temperature	$T_{opr}$	-40 <b>~</b> +100	°C	
Storage Temperature	$T_{stg}$	-40 <b>~</b> +105	°C	
Electro Static Discharge Threshold "HBM"	ESD	1,000	V	Note
Soldering Temperature "Reflow Soldering"	$T_{sld}$	260	°C	Note

Notes1

Notes1 ESD testing method: EIAJ4701/300(304) Human Bodu Model (HBM) 1.5kΩ,100pF

Notes2 Please refer to page 8, "Soldering Conditions".

#### [ Thermal Characteristics ]

(Ta=25°C)

ПЕМ	SYMBOL	TYP.	MAX.	UNITS	
Thermal resistance 【Junction - Ambient】	R <sub>th(j-a)</sub>	500	-	°C/W	Notes3
Thermal resistance [Junction - Solder point]	$R_{th(j-s)}$	300	-	°C/W	
Junction Temperature	Tj	-	105	°C/W	

Notes 3  $R_{th(j-a)}$  Measurement Condition

Substrate : FR4(t=1.6mm)

• Pattern Size: 16mm2



# **Specifications**

#### VCDB1111C-5AY3B-TR

### **[** Electro and Optical Characteristics ]

(Ta=25°C)

						(1a-23 C)
ITEM	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Forward Voltage	$V_{F}$	I <sub>F</sub> = 5mA	2.6	3.0	3.3	V
Reverse Current	I <sub>R</sub>	$V_R = 5V$	-	-	10	μА
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> = 5mA	6.8	-	18	mcd
Luminous Flux	φ ν	I <sub>F</sub> = 5mA	-	42	-	mlm
Peak Wavelength	λр	I <sub>F</sub> = 5mA	-	463	-	nm
Dominant Wavelength	λd	I <sub>F</sub> = 5mA	464	470	476	nm
Spectral Line Half Width	Δλ	I <sub>F</sub> = 5mA	-	22	-	nm
Half Intensity Angle	2θ 1/2	I <sub>F</sub> = 5mA	-	110	-	deg.

Notes

Above the table of Luminous Intensity (IV) values and Dominant Wavelength ( $\lambda$  d) values are the setup value of the selection machine. [Tolerance : IV...±10%,  $\lambda$  d...±1nm]

### 【 Sorting for Luminous Intensity and Dominant Wavelength 】

LEDs shall be sorted out into the following ranks of Luminous Intensity and Dominant Wavelength.

Luminous Intensity (Iv) Rank
------------------------------

|--|

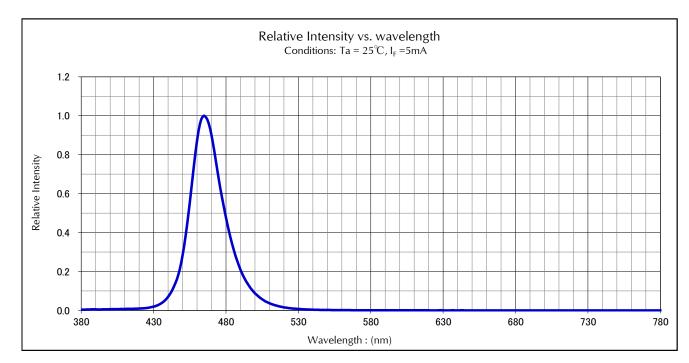
Rank	I <sub>V</sub> (n	CONDITIONS	
Kank	MIN.	MAX.	CONDITIONS
AY	6.8	8.2	
AZ	8.2	10.0	
B1	10.0	12.0	I <sub>F</sub> =5mA Ta=25 <b>°C</b>
B2	12.0	15.0	25 0
В3	15.0	18.0	

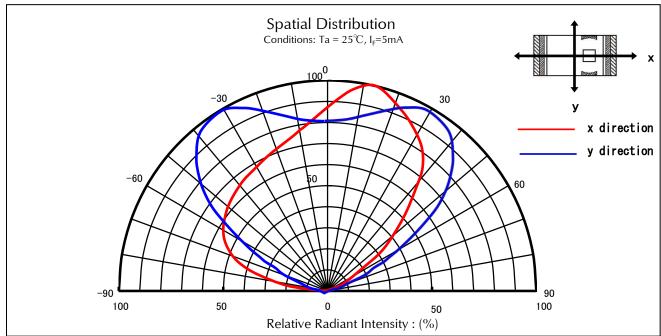
Danil	λd	CONDITIONS	
Rank	MIN.	MAX.	CONDITIONS
В	464	468	
С	468	472	I <sub>F</sub> =5mA Ta=25 <b>°C</b>
D	472	476	. 14 23 0

Notes

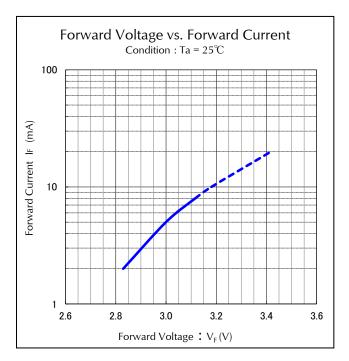
Above the table of Luminous Intensity (IV) values and Dominant Wavelength ( $\lambda$  d) values are the setup value of the selection machine.

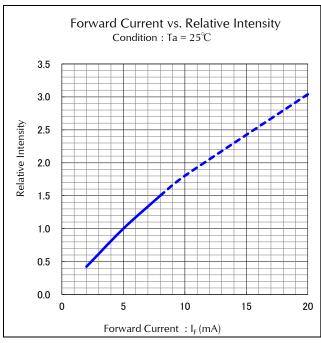
[Tolerance : IV...±10%, \(\lambda\) d...±1nm]

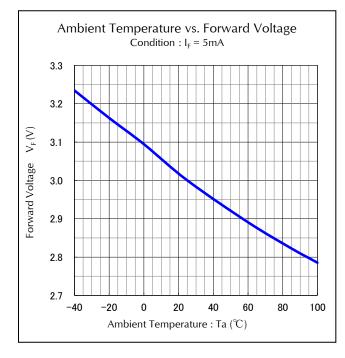


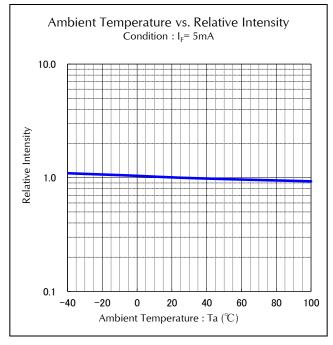




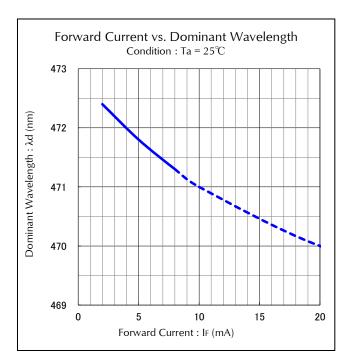


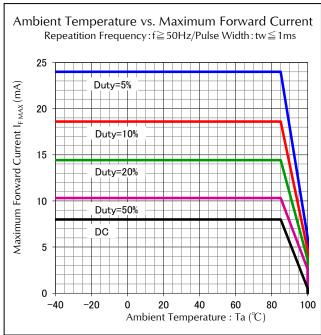


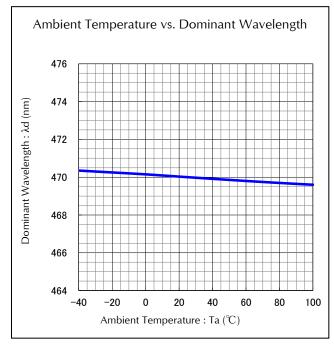


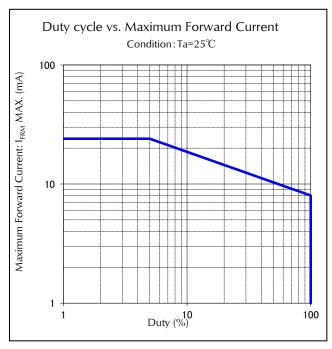






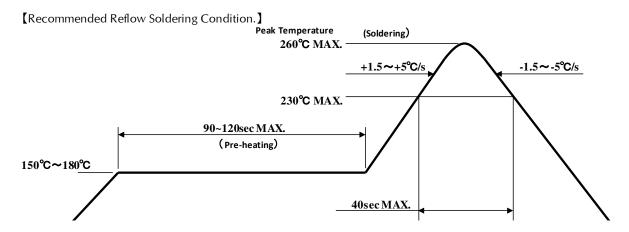






# **Soldering conditions**

#### 1. Reflow Soldering



- The above temp. profile shall be at the surface of LED resin.
- 2. The number of reflow process shall be 2 time MAX. If second reflow process would be performed, intervals between first and second process shall be as short as possible to prevent absorption of moisture to resin of LED. Cooling process to normal temp. shall be required between first and second reflow process.
- 3. Temp. fluctuation to LED at pre-heat process shall be minimized.

#### 2. Manual Soldering (Soldering iron)

Temperature of Iron Tip	350℃MAX.
Soldering Duration, Time	3sec.MAX.,1 time

<sup>\*</sup> The number of manual soldering process shall be 1 time.

#### 3. Other Caution

- 1. As manual soldering, please heat the solder pad, should not contact a tip of iron to a product (especially resin).
- 2. Heat or UV(or both) curing resin shall used for preliminary fixing. Curing condition temp. : 150  $^{\circ}$ C MAX. , time : 120s MAX.
- 3. After soldering, any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp.



# **Soldering condition**

# VCDB1111C-5AY3B-TR

- 4. If soldering manually, Stanley recommends using a soldering iron equipped with temperature control. During the actual soldering process, make sure that the soldering iron never touches the LED itself, and avoid the LED's electrode heating temperature reaching above the heating temperature of the solder pad. All repairs must be performed only once in the same spot, and please avoid reusing components.
- 5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature before using. Also, please avoid applying any types of pressure to the soldered components before the solder has been cooled and hardened, as it may deteriorate solder performance and solder quality.

#### **[Recommended Manual Soldering Condition]**

Temperature of Iron Tip	350℃MAX.
Soldering Duration, Time	3sec.Max.,1 time

- 6. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation (UV) setting resin with heat shall be recommended. «The curing condition, Temperature:150°CMax./Time:300sec.Max.»
- 7. Flow soldering (dip soldering) is not recommended for this product.
- 8. Isopropyl alcohol is recommended for cleaning. Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on. Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component. Cleaning with ultrasonic is not recommended.

Chemical	Adaptability
Ethyl Alcohol	0
Isopropyl Alcohol	0
Pure Water	0
Trichloroethylene	×
Chlorothene	×
Acetone	×
Thinner	×

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# **Handling Precaution**

# VCDB1111C-5AY3B-TR

#### [For Electric Static Discharge (ESD)]

This type of LED lamp is highly sensitive to surge voltage generated by the On/Off status change and discharges of static electricity through frictions with synthetic materials, which may cause severe damage to the die or undermine its reliability. Damaged products may experience conditions such as extremely high reverse voltage, or a decrease of forward rise voltage, deteriorating its optical characteristic. Stanley products are designed to withstand up to 1,000V under the EIAJ ED-4701/300 Test #304 (HBM), and are packed with anti-static components. However, the following precautions and measures are vital in ensuring product quality during shipment.

EIAJ ED-4701/300 (304/HBM) Electrification model: C=100pF, R2=1.5K $\Omega$ 

#### 1. Electrification/Static Electricity protection

Stanley recommends the following precautions in order to avoid product (die) damage from static electricity, when an operator and other materials electrified by friction coming in contact with the product.

- ① Do not place electrified non-conductive materials near the LED product.

  Avoid LED products from coming into contact with metallic materials.( Should the metallic material be electrified, the sudden surge voltage will most likely damage the product.)
- ② Avoid a working process which may cause the LED product to rub against other materials.
- 3 Install ground wires for any equipment, where they can be installed, with measures to avoid static electricity surges.
- **4** Prepare a ESD protective area by placing a Conductive Mattress ( $1M\Omega$  MAX.) and Ionizer to remove any static electricity.
- ⑤ Operators should wear a protective wrist-strap.
- 6 Operators should wear conductive work-clothes and shoes.
- To handle the products directly, Stanley recommends the use of ceramic, and not metallic, tweezers.

#### 2. Working Environment

- ① A dry environment is more likely to cause static electricity. Although a dry environment is ideal for storage state of LED products, Stanley recommends an environment with approximately 50% humidity after the soldering process.
- ② Recommended static electricity level in the working environment is 150V, which is the same value as Integrated Circuits (which are sensitive to static electricity).

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# **Handling Precaution**

#### VCDB1111C-5AY3B-TR

#### **Other Precautions**

- 1. Stanley LED Lamps have semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions.
- 2. Absolute Maximum Ratings are set to prevent LED lamps from failing due to excess stress( temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.
- 3. In order to ensure high reliability from LED Lamps, variable factors that arise in actual usage conditions should be taken it to account for designing. ( Derating of TYP., MAX Forward Voltage, etc.)
- 4. Please insert Straight Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
- 5. Please be careful when LED is soldered on a metal plate, since solder crack might be caused by heat .
- 6. Please avoid using this product with materials or products that contain sulfur or chlorine element which may damage the product. Keep the product in desiccator regardless of before or after mounting to prevent corrosive gas. Also make sure there is no corrosive gas which occurs in surrounding area or invade from outside when using products.
- 7. Please avoid the stick of foreign material because molding resin in the products have adhesiveness. And please don't touch lens portion.
- 8. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
- 9. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
- 10. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
- 11. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health ( such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
- 12. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

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# **Packaging Specifications**

#### VCDB1111C-5AY3B-TR

This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

#### [Recommended Storage Condition / Products Warranty Period ]

Temperature	+5 <b>~</b> 30℃
Humidity	Under 70%

In the case of the package unopened, 6 months under [Recommended Storage Condition]. Please avoid rapid transition from low temp. condition to high temp. condition and storage in corroding and dusty environment.

#### **Time elapsed after Package Opening**

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering which is **[maximum 168h]**. If the device needs to be soldered twice, both soldering operations must be completed within 168h.

If any components should remain unused, please reseal the package and store them under the conditions described in the [ Recommended Storage Condition ] above.

This product must be required to perform baking process (moisture removal) for **10h(min.)** to **12h(max.)** at **60+/-5 degrees Celsius** if following conditions apply.

- 1.In the case of silica gel (blue) which indicates the moisture level within the package, changes or loses its blue color.
- 2. In the case of time passes for 168h after the package is opened once.

Baking process should be performed after LED having been taken out of the package.

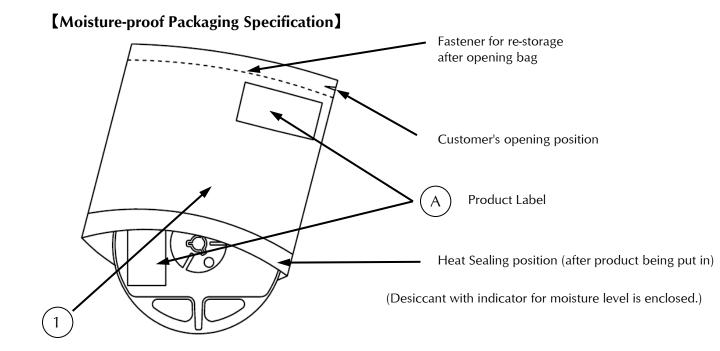
Baking may be performed in the tape-reel form, however if it is performed with the reel stacked over one another, it may cause deformation of the reels and taping materials and later obstruct mounting. Please handle only once it has returned to room temperature. Provided that, baking process shall be 2 times MAX.

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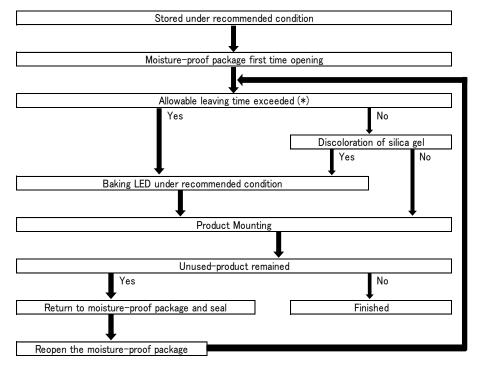
# **Packaging Specifications**

# VCDB1111C-5AY3B-TR



SYM.	PART NAME	MATELRIAL	REMARKS
1	Moisture-proof bag with Aluminum layer	PET+Al+PE	with ESD protection

#### **[Flow Chart-package Opening to Mounting]**



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type.

The allowable leaving time should be calculated form the first opening of package to the time when soldering process is finished.

When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated form the first opening of package, or from the time when baking process is finished.

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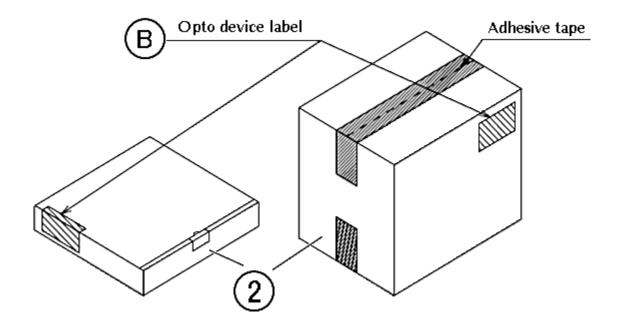
### [Packing box]

(RoHS•ELV Compliant)

Box type	Outline dimension L × W × H (mm)	Capacity of the box
Type A	280 × 265 × 45	3 reels
Type B	310 × 235 × 265	15 reels
Type C	440 × 310 × 265	30 reels

The above measure is all the reference value.

Shipping box is selected out of the above table by shipping quantity.



Type A

Material / box : Cardboard C5BF

Type B,C

Material / box : Cardboard K5AF

Partition : Cardboard K5AF

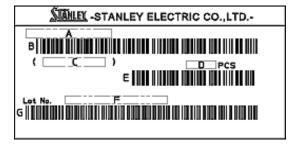
No.	PART NAME	MATELRIAL	REMARKS
2	Packing Box	Corrugated Cardboard	without ESD protection

# **Packaging Specifications**

#### **[Label Specification]**

(acc.to JIS-X0503(Code-39))

# (A) Product Label

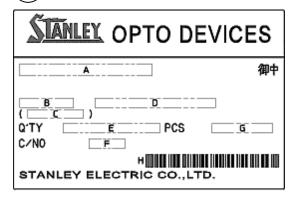


- A. Parts number
- B. Bar-code for parts number
- C. Parts code (In-house identification code for each parts number)
- D. Packed parts quantity
- E. Bar-Code for packed parts quantity
- F. Lot number & Rank

(refer to Lot Number Notational System for details )

G. Bar-Code for Lot number & Rank

# (B) Opto Device Label



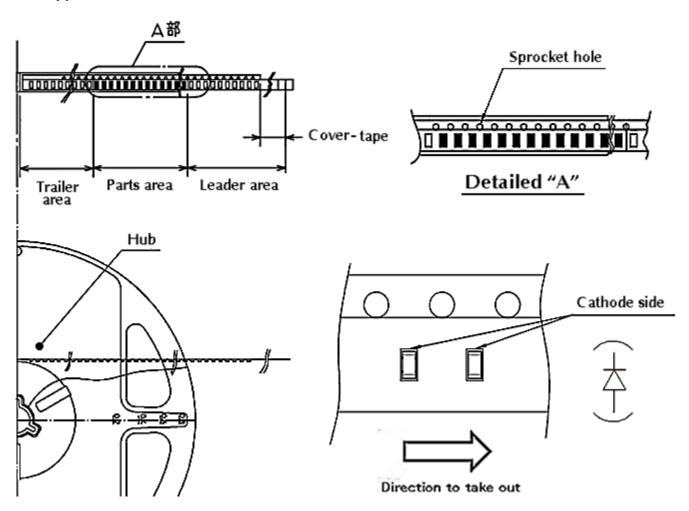
- A. Customer Name
- B. Parts Type
- C. Parts Code
- D. Parts Number
- E. Packed Parts Quantity
- F. Carton Number
- G. Shipping Date
- H. Bar-Code for In-house identification Number

<Remark> Bar-code font : acc.to Code-39(JIX0503)



(acc.to JIS-C0806-03)

### [Appearance]



#### Note

<sup>&</sup>quot;-TR" means Cathode Side of LEDs should be placed on the sprocket-hole side.

lte	ms	Specifications	Remarks
Landanana	Cover-tane I		The end of cover-tape shall be held with adhesive tape.
Leader area  Carrier-tape		Empty pocket shall be more than 10 pieces.	Please refer to the above figure for Taping & reel orientation .
Trailer area		Empty pocket shall be more than 15 pieces.	The end of taping shall be inserted into a slit of the hub.



# **Taping and Reel Specifications**

(acc.to JIS-C0806-03)

#### **[Qty. per Reel]**

4,000parts/reel

Minimum Qty. per reel might be 500 parts when getting less than 4,000 parts.

In such case, parts of 500-unit-qty. shall be packed in a reel and the qty.shall be identified on the label

#### [Mechanical strength]

Cover-tape adhesive strength shall be  $0.1 \sim 1.0 \text{N}$  (An angle between carrier-tape and cover-tape shall be 170 deg.). Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

#### [Others]

Reversed-orientation, Up-side down placing, side placing and out of spec. parts mix shall not be held. Max qty. of empty pocket per reel shall be defined as the following.

Qty./reel	Max. qty. of empty pocket	Remark
500	1	-
1,000	1	-
1,500	2	-
2,000	2	No continuance
2,500	3	No continuance
3,000	3	No continuance
3,500	4	No continuance
4,000	4	No continuance



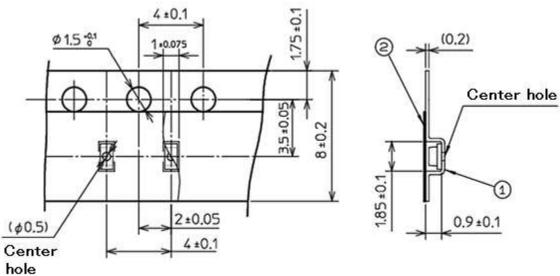
# **Taping and Reel Specifications**

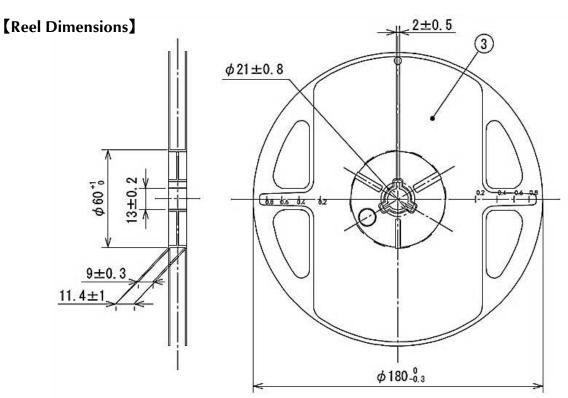
# VCDB1111C-5AY3B-TR

(acc.to JIS-C0806-03)

Unit:mm

# **[Taping Dimensions]**

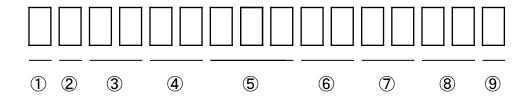




SYMBOL	PART NAME	REMARKS
1	Carrier-tape	with ESD protection
2	Cover - tape	with ESD protection
3	Carrier-real	with ESD protection







① - 1digit: Production Location (Mark identify alphabet)

② - 1digit: Production Year (Last digit of Production Year 2009→9,2010→0,2011→1,···)

③ - 2digits: Production Month (Jan. to Sep., should be 01,02,03,....)

4 - 2digits : Production Date

**⑤** - 3digits: Serial Number

6 - 2digits: Tape and Reel following Number

7 - 2digits: Luminous Intensity Rank.

(If luminous intensity rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified intensity rank, "--" is used to indicate.)

8 - 2digits: Chromaticity Rank

(If chromaticity rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified intensity rank, "--" is used to indicate.)

9 - 1digit : Option Rank (Stanley normally print "-" to indicate)



# **Correspondence to RoHS•ELV instruction**

### VCDB1111C-5AY3B-TR

This product is in compliance with RoHS•ELV.

Prohibition substance and it's criteria value of RoHS•ELV are as follows.

- •RoHS instruction ..... Refer to following  $(1) \sim (6)$ .
- •ELV instruction ....... Refer to following  $(1) \sim (4)$ .

	Substance Group Name	Criteria Value
(1)	Lead and its compounds	1,000ppm Max
(2)	Cadmium and its compounds	100ppm Max
(3)	Mercury and its compounds	1,000ppm Max
(4)	Hexavalent chromium	1,000ppm Max
(5)	PBB	1,000ppm Max
(6)	PBDE	1,000ppm Max



# **Reliability Testing Result**

# VCDB1111C-5AY3B-TR

### 1. Reliability Testing Result

Test Item	Standard	Test Condition	Duration	Failure
Operating Life	EIAJ ED-4701 /100(101)	Ta=25° <b>C</b> I <sub>F</sub> =8mA	1,000h	0 / 20
High Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=85° <b>C</b> I <sub>F</sub> =8mA	1,000h	0 / 20
Low Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=-40°C I <sub>F</sub> =8mA	1,000h	0 / 20
Wet High Temperature Operating Life	EIAJ ED-4701 /100(102)	Ta=60°C 90% I <sub>F</sub> =8mA	1,000h	0 / 20
High Temperature Storage Life	EIAJ ED-4701 /200(201)	Ta=105 <b>°C</b>	1,000h	0 / 20
Low Temperature Storage Life	EIAJ ED-4701 /200(202)	Ta=-40° <b>C</b>	1,000h	0 / 20
Wet High Temperature Storage Life	EIAJ ED-4701 /200(202)	Ta=60°C 90%	1,000h	0 / 20
Thermal Shock	EIAJ ED-4701 /100(105)	Ta=−40°C ~ 105°C (each 15min)	1,000 cycles	0 / 20
Resistance to Reflow Soldering	EIAJ ED-4701 /300(301)	Moisture Soak: 30°C 70% 168h Preheating: 150~180°C 120sec MAX. Soldering: 260°C 5sec	2 times	0 / 20
Electrostatic Discharge (ESD) <b>※ 1</b>	EIAJ ED-4701 /300(304)	C=100pF R2=1.5kΩ ±2,000V	Once of each polarity	0 / 10
Vibration, Variable Frequency	EIAJ ED-4701 /400(403)	98.1m/s <sup>2</sup> (10G) 100~ 2,000Hz 20min. sweep XYZ direction	2h of each direction	0 / 10

#### ★ 1 Reference test

#### 2. Failure Criteria

ltem	Symbol	Conditions	Failure Criteria
Luminous Intensity	$I_{ m V}$	I <sub>F</sub> =5mA	Testing Min. Value < Standard Min. Value × 0.5
Forward Voltage	$V_{F}$	I <sub>F</sub> =5mA	Testing Max. Value ≧ Standard Max. Value × 1.2
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	Testing Max. Value ≧ Standard Max. Value × 2.5
Cosmetic appearance	-	-	Notable Discoloration, Deformation and Cracking



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